ASSOCIATION CONNE	© Copyright 2005. II	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						Afg Inf	ormation		
Supplier Info	rmation								·						
Company name*			Company uni	Company unique ID			Unique ID Authority					Response Date*			
nsemi											2024-0	2024-05-11			
Contact Name		Title - Contac	Title - Contact			Phone - Contact*				Email	Email - Contact*				
Product-Env-Ste	ewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
uthorized Repr	esentative*	Title - Representative			I	Phone - Representative*				Email	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Reque	ester Item Number Mfr Iter		m Number Mfr Item Name				Effective Date Ver		on N	Manufacturing Site		Weight*		UOM	Unit Type
		MM74HCT574MTCX OCTAI		OCTAL D FLIP	CTAL D FLIP FLOP		2024-05-11	024-05-11 PH1			73.35 mg		mg	Each	
Ianufacturi r	ng Proccess Informat	tion													
Termin	nal Plating / Grid Array Ma	Plating / Grid Array Material Terr		Terminal Base Alloy J-		020 MSL Rating		Peak Process Body Temperatur		e Max Time at Peak Temper		ature Number of Reflow Cycles		eles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		С	30	seco	nds	3		
Comments															
vel 1 - maximu	m time at peak temperatu	re during so	ldering is 10-3	0 seconds											
or more inform	ation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a						
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.25	mg	Supplier	Silicon (Si)	7440-21-3		1.25	mg
Die Attach	0.136	mg		Epoxy resin	proprietary data		0.0136	mg
			Supplier	Silver (Ag)	7440-22-4		0.1088	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0136	mg
Lead Frame	30.624	mg	Supplier	Zinc (Zn)	7440-66-6		0.0367	mg
			Supplier	Iron (Fe)	7439-89-6		0.7197	mg
			Supplier	Copper (Cu)	7440-50-8		29.8584	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0092	mg
Mold Compound-Black	40.867	mg		Epoxy resin	proprietary data		3.065	mg
			Supplier	Phenolic Resin	Proprietary Data		1.0217	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		3.065	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2043	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		33.5109	mg
Plating	0.223	mg	Supplier	Palladium (Pd)	7440-05-3		0.006	mg
			В	Nickel (Ni)	7440-02-0		0.213	mg
			Supplier	Gold (Au)	7440-57-5		0.004	mg
Wire Bond - Cu	0.25	mg	Supplier	Copper (Cu)	7440-50-8		0.25	mg